A hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail, in an envelope addressed to: Commissioner for Patents, Washington, DC 20231, on the date shown below.

Dated: November 18, 2002 Signature:

[Kimberly V. Perryy]

#7/Response
12/6/R
N

Docket No.: TESSERA 3.0-255 (PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Warner et al.

Application No.: 09/811,803

Group Art Unit: 2823

Filed: March 19, 2001

Examiner: Fernando Toledo

For: METHODS OF MAKING MICROELECTRONIC

ASSEMBLIES USING COMPRESSED

RESILIENT LAYER

Commissioner for Patents Washington, DC 20231

AMENDMENT

Dear Sir:

In response to the Official Action mailed July 17, 2002, Applicants submit the following remarks.